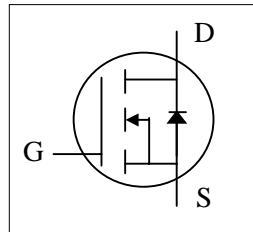




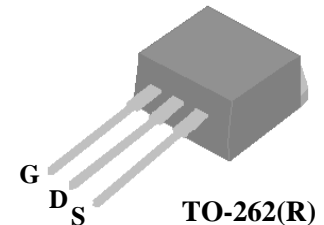
- ▼ 100% Avalanche Test
- ▼ Fast Switching
- ▼ Simple Drive Requirement



BV_{DSS}	650V
$R_{DS(ON)}$	0.75 Ω
I_D	9A

Description

AP09N70 series are specially designed as main switching devices for universal 90~265VAC off-line AC/DC converter applications. TO-262 type provide high blocking voltage to overcome voltage surge and sag in the toughest power system with the best combination of fast switching, ruggedized design and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	650	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D@T_C=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	9	A
$I_D@T_C=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	5	A
I_{DM}	Pulsed Drain Current ¹	40	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	156	W
	Linear Derating Factor	1.25	W/ $^\circ C$
E_{AS}	Single Pulse Avalanche Energy ²	305	mJ
I_{AR}	Avalanche Current	9	A
E_{AR}	Repetitive Avalanche Energy	9	mJ
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-c	Maximum Thermal Resistance, Junction-case	0.8	$^\circ C/W$
Rthj-a	Maximum Thermal Resistance, Junction-ambient	62	$^\circ C/W$



Electrical Characteristics @ $T_j=25^{\circ}\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=1mA$	650	-	-	V
$\Delta BV_{DSS}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to $25^{\circ}\text{C}, I_D=1mA$	-	0.6	-	$V/^{\circ}\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance ³	$V_{GS}=10V, I_D=4.5A$	-	-	0.75	Ω
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
g_{fs}	Forward Transconductance	$V_{DS}=10V, I_D=4.5A$	-	4.5	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=650V, V_{GS}=0V$	-	-	10	μA
	Drain-Source Leakage Current ($T_j=125^{\circ}\text{C}$)	$V_{DS}=520V, V_{GS}=0V$	-	-	500	μA
I_{GSS}	Gate-Source Leakage	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	+100	nA
Q_g	Total Gate Charge ³	$I_D=9A$	-	44	-	nC
Q_{gs}	Gate-Source Charge	$V_{DS}=480V$	-	11	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	12	-	nC
$t_{d(on)}$	Turn-on Delay Time ³	$V_{DD}=300V$	-	19	-	ns
t_r	Rise Time	$I_D=9A$	-	21	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=10\Omega, V_{GS}=10V$	-	56	-	ns
t_f	Fall Time	$R_D=34\Omega$	-	24	-	ns
C_{iss}	Input Capacitance	$V_{GS}=0V$	-	2660	-	pF
C_{oss}	Output Capacitance	$V_{DS}=25V$	-	170	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0MHz$	-	10	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_S	Continuous Source Current (Body Diode)	$V_D=V_G=0V, V_S=1.5V$	-	-	9	A
I_{SM}	Pulsed Source Current (Body Diode) ¹		-	-	40	A
V_{SD}	Forward On Voltage ³	$T_j=25^{\circ}\text{C}, I_S=9A, V_{GS}=0V$	-	-	1.5	V

Notes:

- 1.Pulse width limited by Max. junction temperature
- 2.Starting $T_j=25^{\circ}\text{C}, V_{DD}=50V, L=6.8mH, R_G=25\Omega, I_{AS}=9A$.
- 3.Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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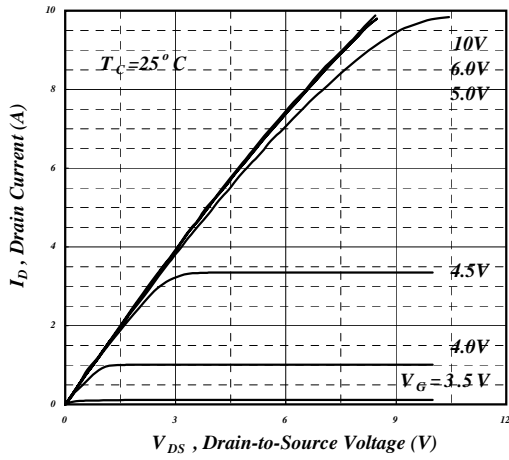


Fig 1. Typical Output Characteristics

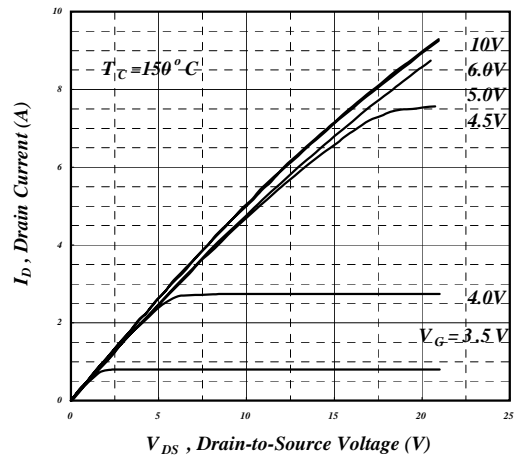


Fig 2. Typical Output Characteristics

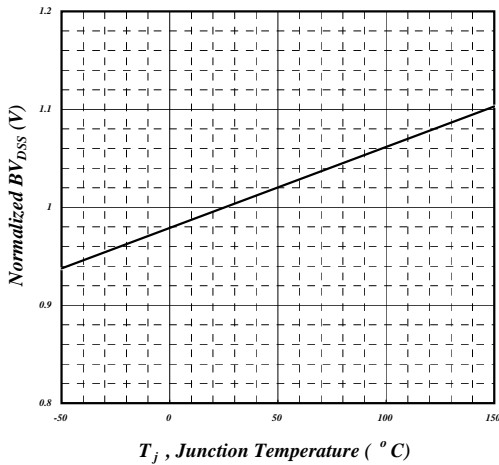


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

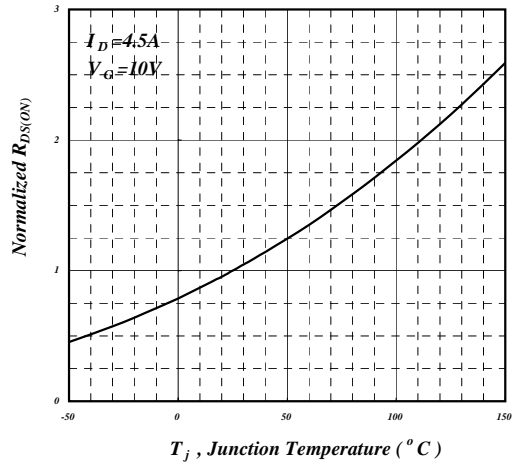


Fig 4. Normalized On-Resistance v.s. Junction Temperature

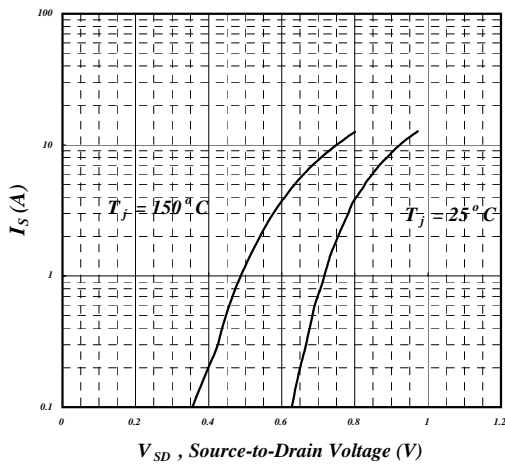


Fig 5. Forward Characteristic of Reverse Diode

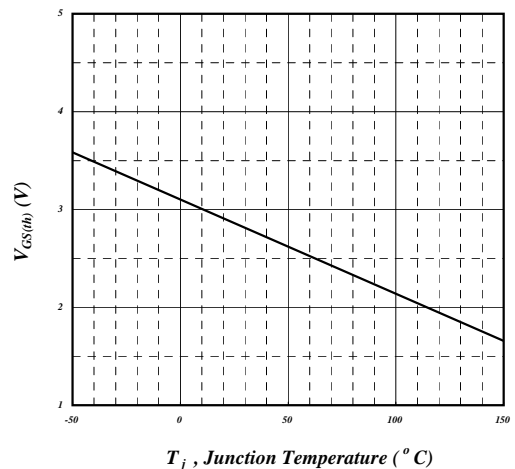


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

